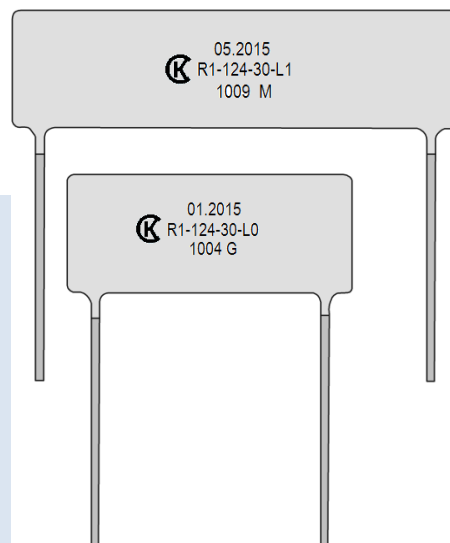
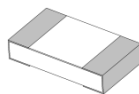


### FEATURES

- 40000 V capability

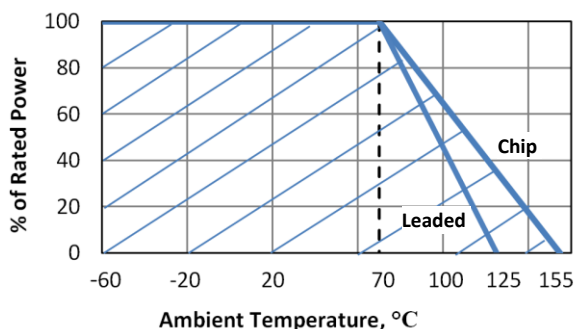


### GENERAL SPECIFICATIONS

- **Operating Temp. Range:** -60 °C to 125 °C<sub>(lead)</sub> to 155 °C<sub>(chip)</sub>
- **Load Life 70 °C/ 1000 h:** 5 %
- **Max. Resistance Change at Rated Dissipation |ΔR/R max. | after 15000 h** 10%
- **Package:** Leaded, chip
- **Process:** Thickfilm
- **Substrate Material:** 96 % Al<sub>2</sub>O<sub>3</sub>
- **Coating:** Epoxy
- **Termination Finish:** Sn-Pb

Part Number	Power (W)	Max. Working Voltage (V)	Resistance Value <sup>1</sup> , E24 Series(Ohms)	Resistance Tolerance (± %)
R1-124-10-C0	1	1000	1M-10M	20, 10, 5, 2
			11M-10G	20, 10, 5
			11G-100G	20, 10
R1-124-15-C0	1.5	4000	1M-10M	20, 10, 5, 2
			11M-10G	20, 10, 5
			11G-100G	20, 10
R1-124-05-L0	0.5	5000	1M-1G	10, 5, 2
R1-124-10-L0	1	10000	1M-2G	10, 5, 2
R1-124-30-L0	3	15000	1M-2G	10, 5, 2
R1-124-50-L0	5	20000	1M-3G	10, 5, 2
R1-124-10-L1	1	20000	1M-10M	20, 10, 5, 2
			11M-10G	20, 10, 5
			11G-100G	20, 10
R1-124-30-L1	3	30000	1M-10M	20, 10, 5, 2
			11M-10G	20, 10, 5
			11G-100G	20, 10
R1-124-50-L1	5	40000	1M-10M	20, 10, 5, 2
			11M-10G	20, 10, 5
			11G-100G	20, 10

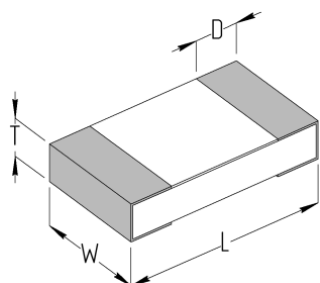
<sup>(1)</sup> <100M measured at 10 V, >100M measured at 100 V, >10G measured at 200 V



### PART NUMBER CODE

<b>R1-124</b>	<b>15</b>	<b>L0</b>	<b>5104</b>	<b>K</b>	<b>C</b>
model	power	package	value	tolerance	Packaging
	05 = 0.5 W	Lx -leaded	5104 = 5.1MΩ	G = 2 %	C-cartonbox
	10 = 1 W	Cx-chip	1009 = 100GΩ	J = 5 %	T-tape & reel
	15 = 1.5 W			K = 10 %	
	30 = 3 W			M = 20 %	
	50 = 5 W				

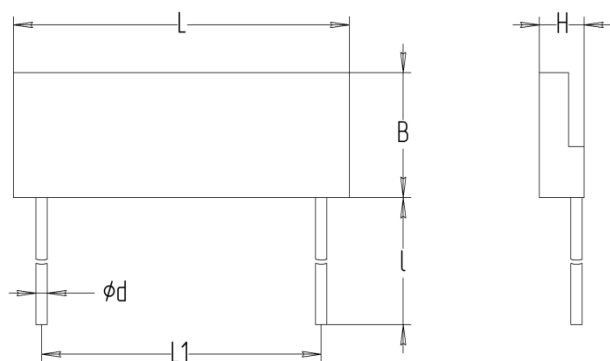
### R1-124-xx-C0-xxxx-x



Part Number	Dimensions (mm)				Mass (g)
	L	W	T	D	
R1-124-10-C0	6.3±0.2	3.2±0.2	0.6±0.2	0.75±0.45	0.1
R1-124-15-C0	10.0±0.2	0.5±0.2	0.6±0.2	1.0±0.5	0.5

Termination Style: 3-sided wraparound

### R1-124-xx-Lx-xxxx-x



Part Number	Dimensions (mm)						Mass (g)
	L	B	H	L1	l	Ød	
R1-124-05-L0	20.0 <sup>+1.0</sup>	8.0 <sup>+0.6</sup>	2.2max	18.0 <sup>+1.0</sup>	18 min	0.5	0.5
R1-124-10-L0	24.0 <sup>+1.0</sup>	15.0 <sup>+0.6</sup>	2.8 max	21.0 <sup>+1.0</sup>	20 min	0.8±0.1	1.7
R1-124-30-L0	30.0 <sup>+1.0</sup>	20.0 <sup>+0.6</sup>	2.8 max	26.0 <sup>+1.0</sup>	25 min	0.8±0.1	2.8
R1-124-50-L0	48.0 <sup>+1.0</sup>	20.0 <sup>+0.6</sup>	2.8 max	44.0 <sup>+1.0</sup>	25 min	0.8±0.1	4.5
R1-124-10-L1	38.0 <sup>+3</sup>	13.0 <sup>+3</sup>	2.5±0.5	35.2±0.5	35.0±0.1	0.8±0.1	2.8
R1-124-30-L1	51.0 <sup>+3</sup>	15.0 <sup>+3</sup>	2.5±0.5	48.2±0.5	35.0±0.1	0.8±0.1	4.5
R1-124-50-L1	76.0 <sup>+3</sup>	15.0 <sup>+3</sup>	2.5±0.5	73.2±0.5	35.0±0.1	0.8±0.1	5.5

### PERFORMANCE CHARACTERISTICS

Test	Condition	ΔR max.
Robustness of termination <sup>1</sup>	IEC60115-1 (4.16)/ IEC 60068-2-21 Bending;Tensile	±5 %
Solderability	IEC60115-1 (4.17)/ IEC 60068-2-20 (235±5) °C; 2 s;solder bath method;SnPb40	Good tinning (>95 % covered, no visible damage)
Resistance to soldering heat	IEC60115-1 (4.18.2)/ IEC 60068-2-20 (260±5) °C;(5±1) s	± 5 %; no visible damage
Rapid change of temperature	IEC60115-1 (4.19)/ IEC 60068-2-14 30 min at -60 °C; 30 min at 125°C; 5 cycles (lead) 30 min at -60 °C; 30 min at 155 °C; 5 cycles (chip)	±5 %
Vibration <sup>1</sup>	IEC60115-1 (4.22)/ IEC 60068-2-6 32 sweep cycles per direction;100 Hz to 2000 Hz;50 m/s <sup>2</sup>	± 5 %
Damp heat, steady state	IEC60115-1 (4.24)/ IEC 60068-2-78 (40±2) °C;56 days;(93±3) % RH	± 20 %

<sup>(1)</sup> only R1-124-xx-Lx

All tests are carried out in accordance with the following specifications:

- IEC 60115-1 (clause),
- IEC 60068-2-xx (test method).

### PACKAGING

**For manual assembly:** R1-124-xx-Lx-xxxx-x-C  
carton box.

**For automatic assembly:** R1-124-xx-Cx-xxxx-x-T  
tape and reel (>500 pcs).

### MARKING(E24)

Nominal value		Marking	
1M	to 9.1M	1004	to 9104
10M	to 91M	1005	to 9105
100M	to 910M	1006	to 9106
1G	to 9.1G	1007	to 9107
10G	to 91G	1008	to 9108
100G		1009	

### MOUNTING PROCEDURE

- **R1-124-xx-Cx:** can be used in automatic or manual assembly techniques, do not mount 'face-down'.
- **R1-124-xx-Lx:** can be used only in manual assembly technique.